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1. AGENCY February, 1992		3. REPORT TYPE AND DATES COVERED Final 08-01-91 to 01-31-92	
4. TITLE AND SUBTITLE Enhancement of Fracture Toughness Using High Intensity Electric Currents		5. FUNDING NUMBERS DAAL03-91-G-0240	
6. AUTHOR(S) V.K. Sarin J. Gurland			
7. PERFORMING ORGANIZATION NAME(S) AND ADDRESS(ES) Boston University, The Trustees of 881, Commonwealth Ave Boston MA 02215		8. PERFORMING ORGANIZATION REPORT NUMBER N/A	
9. SPONSORING/MONITORING AGENCY NAME(S) AND ADDRESS(ES) U. S. Army Research Office P. O. Box 12211 Research Triangle Park, NC 27709-2211		10. SPONSORING/MONITORING AGENCY REPORT NUMBER AR0 28821.1-MS	
11. SUPPLEMENTARY NOTES The view, opinions and/or findings contained in this report are those of the author(s) and should not be construed as an official Department of the Army position, policy, or decision, unless so designated by other documentation.			
12a. DISTRIBUTION/AVAILABILITY STATEMENT Approved for public release; distribution unlimited.		12b. DISTRIBUTION CODE	
13. ABSTRACT (Maximum 200 words) The object of this research is to conduct exploratory experiments on the effects of electric current on the fracture characteristics of materials prone to micro-cracking and catastrophic failure. It is anticipated that under controlled conditions, the applied electric current may result in localized heating at the highly stressed zones around the tips of the microcracks, and/or electroplastic effects. If so, the resulting stress relief and microstructural modifications could be utilized to inhibit crack growth under subsequent loading, and thereby in effect, increase the fracture toughness of the damaged microstructure, without necessarily affecting bulk hardness, flow strength and ductility.			
14. SUBJECT TERMS Fracture toughness, electric current		15. NUMBER OF PAGES 6	
		16. PRICE CODE	
17. SECURITY CLASSIFICATION OF REPORT UNCLASSIFIED	18. SECURITY CLASSIFICATION OF THIS PAGE UNCLASSIFIED	19. SECURITY CLASSIFICATION OF ABSTRACT UNCLASSIFIED	20. LIMITATION OF ABSTRACT UL

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HIGH INTENSITY ELECTRIC CURRENTS

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Date: April 8, 1992

U.S. ARMY RESEARCH OFFICE

Contract Number: E02 DAAL03-91-G-0240

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Enhancement of Fracture Toughness Using High Intensity Electric Currents

Background

In recent years there has been a tremendous interest in the fracture behavior of structural materials. One reason for this is the need and use of brittle materials with relatively higher elevated temperature strengths in the aircraft, automotive, and other energy related industries. Exhaustive research is ongoing to try to enhance the fracture toughness of these materials. Most of the recent developments have been geared towards microstructural tailoring via the composite approach. Although considerable success has been achieved, the introduction of such complex processes has lead to product reliability problems, preventing their introduction in commercial applications for which they have been specifically designed. Supplementary techniques of enhancing fracture toughness of materials with defects or damage on the microscale would not only be highly desirable, but could considerably expedite the commercial utilization of some of these materials.

A new concept that hypothesized the application of high-intensity electric currents (HIEC) to modify the toughness characteristics of brittle materials has been forwarded. It was suggested that under controlled conditions, the applied electric current may result in localized heating, and/or electroplastic effects at the highly stressed zones around the tips of the microcracks. If so, the resulting stress relief and microstructural modifications could be utilized to inhibit crack growth under subsequent loading, and thereby in effect, increase the fracture toughness of the damaged microstructure, without necessarily affecting bulk hardness, flow strength and ductility. Based on this concept a feasibility study was conducted to try to establish the validity of this hypothesis.

Material

Several compositions of WC-%Co cemented carbides, were initially investigated (Table 1). These represent a hard and brittle class of materials in which a combination of both brittle (WC) and ductile (the binder: a solid solution of Co[W,C]) modes of fracture must occur for cracks to propagate. Since the fracture processes in this system are fairly well understood [1,2], it was therefore

felt that interpretation of any observed effects of current would be easier. It is generally agreed that the crack first extends along or through the carbide phase, resulting in a connected volume of isolated binder ligaments acting as "bridges". As the crack opens, the ligaments are stretched until they rupture. Therefore, catastrophic fracture in these materials is preceded by a stage of stable crack propagation involving discontinuous microcracking in front of the crack tip. Due to the lowering of the M_s temperature by the presence of W and C in the Co, which effectively retards the martensitic (fcc to hcp) transformation, the binder is present mainly in the high temperature fcc modification. Subsequently, being unstable, stress results in partial transformation of the binder from the fcc to the hcp modification [3]. This transformation, effectively makes the binder phase relatively brittle, resulting in enhanced crack propagation. This effect is unique to the system in that it allows for connection of microcracks through the ductile binder ligaments, thus resulting in catastrophic failure. It is projected that such transformations would be concentrated around crack tips. The effect of HIEC on this transformation is therefore of great interest. Additionally, it is known that the fracture toughness of cemented carbides is rather insensitive to moderate temperature changes. Therefore, this system was considered ideal for the initial exploratory experiments.

Experimental Procedure

The as-received-samples from each of the four categories (Table 1) were cut into small cubes and randomly divided into four groups. Samples from two of these groups were uniaxially compressed at approximately 2758 MPa (approximately half the known compressive strength). All samples were then mounted and metallographically polished using previously developed techniques [4,5] to minimize residual surface stress due to polishing.

Table 1 Nominal compositions of Commercial Materials Investigated

SAMPLE	NOMI NAL COMPOSI TION (wt.%)			WC GRAIN SIZE μ
	WC	Co	Cubic Carbides (TiC,TaC,NbC,etc.)	
1	93.50	6	0.5	Fine (~ 1)
2	93.50	6	0.5	Coarse (4-5)
3	93.81	6	0.2	Fine (1-2)
4	69.50	10	20.5	Medium (2-3)

Appropriate samples were then subjected to the HIEC treatment. A schematic of the apparatus developed for these tests is shown in Figure 1. The DC power supply used had a maximum rating of a 100 amperes, and therefore only the lower end of the current density spectrum (Table 2) could be investigated at this stage. Additionally, due to time limitations, all samples were subjected to a single 1sec. HIEC pulse. It is evident that considerable more testing in terms of process parameters such as, larger current densities, several pulse cycles, AC versus DC currents, to name of few, need to be investigated before the full potential of this technique can be evaluated.

Figure 1. Schematic of the HIEC Apparatus

Surface Fracture Toughness (IFT) and Vickers hardness (H) were determined on polished specimens after the various treatments. A minimum of twelve and up to twenty indentations (which was the case for all data points generated) using 1 Kg load were used to establish each hardness value. Standard procedures were used to calculate the Vickers hardness number. IFT was determined by generating cracks at a 45 Kg load with a Vickers diamond. The lengths of the cracks emanating from the corners of the indentations were measured, and fracture toughness (IFT) was determined using the following equation [6].

$$IFT = 0.113 (H)(D)^{1/2} / (1 + C_L/2D)^{3/2}$$

where H = Vickers hardness, D = average Vickers diagonal, C_L = total crack length ($C_1 + C_2 + C_3 + C_4$ - length of crack emanating from each corner of indentation).

Results and Discussion

Table 2 summarizes the results obtained in this limited feasibility study. Inconsistencies and gaps in both process parameters and material microstructures are due to the fact that several of these remain under investigation. It should be noted that although statistically valid, these results are very preliminary in nature and need considerably more testing and analysis before they can be confirmed. Some interesting trends are highlighted below;

Table 2 Compiled Hardness and Fracture Toughness Data

SAMPLE	TREATMENT	CRACK LEN.	DIAGONAL	HARDNESS	IFT	CUR. DEN.
		μ	μ	Kg/(mm) ²	MPa. m ^{1/2}	A/(mm) ²
1a	As Received	413.0	264.00	1885	14.54	
1b	As Rec. & HIEC	490.0	229.40	1904	14.08	2.35
1c	Compressed	462.0	259.20	1839	12.86	
1d	Comp. & HIEC	453.0	259.20	1878	13.31	2.35
2a	As Received	231.9	288.54	1218	14.09	
2b	As Rec. & HIEC	171.4	290.47	1230	16.08	14.45
2c	Compressed	338.4	289.25	1233	11.87	
2d	Comp. & HIEC	216.5	288.86	1237	14.74	14.45
3a	As Received	474.2	230.35	1660	9.85	
3b	Compressed	528.3	230.72	1657	8.90	
3c	Comp. & HIEC	464.3	230.08	1670	10.05	2.5
4a	As Received	353.9	236.75	1592	11.98	
4b	Compressed	437.3	235.74	1613	10.46	
4c	Comp. & HIEC	409.9	236.06	1608	10.94	3.9

- 1) Hardness values are not significantly effected by either compression or HIEC treatment.
- 2) In all cases a decrease between 10-15% in the as received IFT values after compression was obtained.
- 3) An increase between 3-24% in the IFT values after the HIEC treatment of the compressed specimens
- 4) In category 1, the HIEC treatment had no effect on the as received material, however specimens in group 2 showed significant improvement (14%) in their IFT values
- 5) Limited test results indicate that the presence of a large amount of cubic carbides adversely effect the influence of the HIEC treatment.

The compression result are not surprising since defects introduced by deformation should be microscopic in nature (micro-cracks). Hence, as a

consequence, no influence on a "bulk" property such as hardness is observed while a substantial decrease in fracture toughness (IFT values) is obtained, since it is greatly influenced by local defects. Impressive increases in the IFT values of the compressed samples, especially for the group 2 case, after the HIEC treatment clearly demonstrates the feasibility of this concept. Although preliminary in nature these results are extremely exciting and encouraging. Additionally, it should be noted that due to the feasibility nature of this investigation, several effects of the HIEC treatment have not been fully analyzed.

Due to the limitation of the power supply, high current densities could not be generated. However, it is interesting to note that samples (group 2) that were subjected to the highest current densities (14.45A/mm^2), show the most significant improvement in IFT after the HIEC treatment. In these samples an increase of approximately 14% was obtained when the as-received-samples were HIEC treated, whereas an increase of 24% in the IFT values was observed when the compressed samples were HIEC treated. These increases are phenomenal and extremely exciting. However, it should be pointed out that these tremendous improvements could also be influenced by microstructural factors such as WC grain size and binder mean free path. In the case of fine grained materials (group 1) and low current densities (2.35 A/mm^2) only modest increases were observed. Needless to say, considerable more testing and in depth analysis are necessary before the influence of grain size and density can be isolated and fully understood. Furthermore, it seems that the HIEC treatment has an effect on the fcc to hcp transformation as can be clearly seen between the changes in IFT values observed in samples 2a and 2b. Clearly more work and testing is again necessary to further elucidate this effect.

Preliminary tests indicate that the presence of cubic carbides (group 4) seems to nullify the effect of HIEC treatment. It is projected that this may be due to the influence these additions have on the binder composition. However, due to the limited nature of the tests, a positive conclusion cannot be made.

Conclusions

Feasibility studies have clearly demonstrated that the application of high intensity electric current (HIEC) on damaged microstructures (compressed samples) consistently enhances their fracture toughness (IFT). In certain cases, enhancement in IFT was also observed on the as-received-samples after HIEC treatment. These results unquestionably demonstrate the HIEC treatment can definitely be used to improve the toughness of damaged WC-Co cemented carbide materials. However, considerable more testing and analysis need to be performed on a variety of brittle material systems before the full scope and potential of this process can be fully realized.

References

1. H. F. Fischmeister, S. Schauder, and L.S.Sigl, Science of Hard Materials 3, V.K. Sarin ed.,Elsevier, Essex, England, (1988), p. 305.
2. R.Godse, and J.Gurland, Science of Hard Materials 3, V.K.Sarin ed.,Elsevier, Essex, England, (1988), p. 331.
3. V.K. Sarin and T. Johannesson, Metal Sci. 10 (1975), p 472.
4. M.T. Laugier, Journal of Material Science Letters, 1987, 897-900.
5. V.K. Sarin, Internal GTE Report.
6. A.G. Eavans, and E.A. Charles, Journal of Ameriacan Ceramic Society, 59(7-8), 1976, p371.